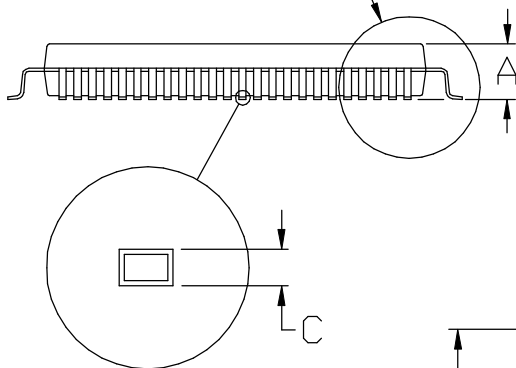


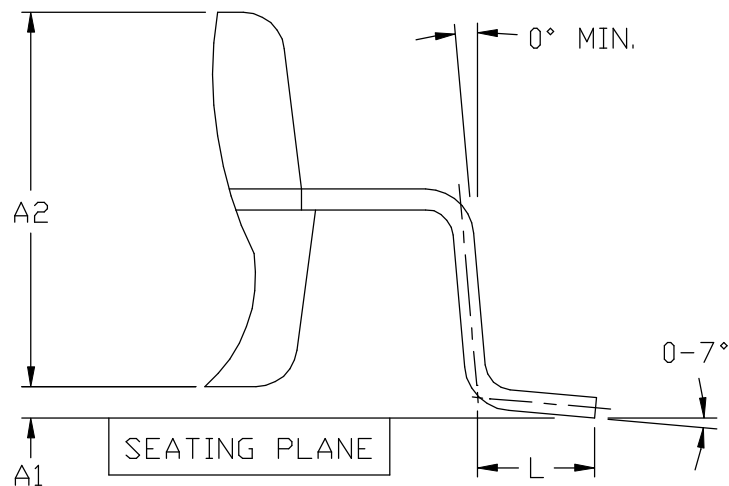
SEE DETAIL "A"



NOTES:


1. DIMENSIONS D1 AND E1 INCLUDE MOLD MISMATCH, BUT DO NOT INCLUDE MOLD PROTRUSION; ALLOWABLE PROTRUSION IS 0.25 MM PER SIDE.
2. DETAILS OF PIN 1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
3. ALLOWABLE DAMBAR PROTRUSION IS 0.08 MM TOTAL IN EXCESS OF THE B DIMENSION; PROTRUSION NOT TO BE LOCATED ON LOWER RADIUS OR FOOT OF LEAD.

DIM	MIN	MAX
A	—	3.40
A1	0.25	—
A2	2.55	2.87
B	0.30	0.45
C	0.13	0.23
D	23.70	24.10
D1	19.90	20.10
E	17.70	18.10
E1	13.90	14.10
e	0.80	BSC
L	0.65	0.95



DETAIL A

DIMENSIONS ARE IN MILLIMETERS

SIGNATURE		DATE		 Dallas Semiconductor TITLE MARKETING OUTLINE, 80 LD. QFP, 14X20 BODY, 1.95 FORM			
DOC. CONTROL:							
ENGR. MGR:							
MFG. ENGR:							
CHECKED BY:							
DRAWN BY:				SIZE A	FSCM NO	PART NO.	REV B
DO NOT SCALE DWG.				SCALE N/A		SHEET 1 OF 1	